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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	dsPIC
Core Size	16-Bit
Speed	30 MIPs
Connectivity	CANbus, I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	68
Program Memory Size	132KB (44K x 24)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	6K x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V
Data Converters	A/D 16x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	80-TQFP
Supplier Device Package	80-TQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/dspic30f6013a-30i-pf

2.0 CPU ARCHITECTURE OVERVIEW

Note: This data sheet summarizes features of this group of dsPIC30F devices and is not intended to be a complete reference source. For more information on the CPU, peripherals, register descriptions and general device functionality, refer to the "*dsPIC30F Family Reference Manual*" (DS70046). For more information on the device instruction set and programming, refer to the *"16-bit MCU and DSC Programmer's Reference Manual"* (DS70157).

2.1 Core Overview

This section contains a brief overview of the CPU architecture of the dsPIC30F. For additional hardware and programming information, please refer to the "*dsPIC30F Family Reference Manual"* (DS70046) and the *"16-bit MCU and DSC Programmer's Reference Manual*" (DS70157), respectively.

The core has a 24-bit instruction word. The Program Counter (PC) is 23-bits wide with the Least Significant bit (LSb) always clear (refer to **Section 3.1 "Program Address Space"**), and the Most Significant bit (MSb) is ignored during normal program execution, except for certain specialized instructions. Thus, the PC can address up to 4M instruction words of user program space. An instruction prefetch mechanism is used to help maintain throughput. Program loop constructs, free from loop count management overhead, are supported using the `DO` and `REPEAT` instructions, both of which are interruptible at any point.

The working register array consists of 16 x 16-bit registers, each of which can act as data, address or offset registers. One working register (W15) operates as a software Stack Pointer for interrupts and calls.

The data space is 64 Kbytes (32K words) and is split into two blocks, referred to as X and Y data memory. Each block has its own independent Address Generation Unit (AGU). Most instructions operate solely through the X memory, AGU, which provides the appearance of a single unified data space. The Multiply-Accumulate (`MAC`) class of dual source DSP instructions operate through both the X and Y AGUs, splitting the data address space into two parts (see **Section 3.2 "Data Address Space"**). The X and Y data space boundary is device specific and cannot be altered by the user. Each data word consists of 2 bytes, and most instructions can address data either as words or bytes.

There are two methods of accessing data stored in program memory:

- The upper 32 Kbytes of data space memory can be mapped into the lower half (user space) of program space at any 16K program word boundary, defined by the 8-bit Program Space Visibility Page (PSVPAG) register. This lets any instruction access program space as if it were data space, with a limitation that the access requires an additional cycle. Moreover, only the lower 16 bits of each instruction word can be accessed using this method.
- Linear indirect access of 32K word pages within program space is also possible using any working register, via table read and write instructions. Table read and write instructions can be used to access all 24 bits of an instruction word.

Overhead-free circular buffers (Modulo Addressing) are supported in both X and Y address spaces. This is primarily intended to remove the loop overhead for DSP algorithms.

The X AGU also supports Bit-Reversed Addressing on destination effective addresses to greatly simplify input or output data reordering for radix-2 FFT algorithms. Refer to **Section 4.0 "Address Generator Units"** for details on modulo and Bit-Reversed Addressing.

The core supports Inherent (no operand), Relative, Literal, Memory Direct, Register Direct, Register Indirect, Register Offset and Literal Offset Addressing modes. Instructions are associated with predefined addressing modes, depending upon their functional requirements.

For most instructions, the core is capable of executing a data (or program data) memory read, a working register (data) read, a data memory write and a program (instruction) memory read per instruction cycle. As a result, 3-operand instructions are supported, allowing C = A + B operations to be executed in a single cycle.

A DSP engine has been included to significantly enhance the core arithmetic capability and throughput. It features a high-speed 17-bit by 17-bit multiplier, a 40-bit ALU, two 40-bit saturating accumulators and a 40-bit bidirectional barrel shifter. Data in the accumulator or any working register can be shifted up to 16 bits right, or 16 bits left in a single cycle. The DSP instructions operate seamlessly with all other instructions and have been designed for optimal real-time performance. The `MAC` class of instructions can concurrently fetch two data operands from memory while multiplying two W registers. To enable this concurrent fetching of data operands, the data space has been split for these instructions and linear for all others. This has been achieved in a transparent and flexible manner, by dedicating certain working registers to each address space for the `MAC` class of instructions.

3.1.1 DATA ACCESS FROM PROGRAM MEMORY USING TABLE INSTRUCTIONS

This architecture fetches 24-bit wide program memory. Consequently, instructions are always aligned. However, as the architecture is modified Harvard, data can also be present in program space.

There are two methods by which program space can be accessed: via special table instructions, or through the remapping of a 16K word program space page into the upper half of data space (see **Section 3.1.2 "Data Access From Program Memory using Program Space Visibility"**). The TBLRDL and TBLWTL instructions offer a direct method of reading or writing the lsw of any address within program space, without going through data space. The TBLRDH and TBLWTH instructions are the only method whereby the upper 8 bits of a program space word can be accessed as data.

The PC is incremented by two for each successive 24-bit program word. This allows program memory addresses to directly map to data space addresses. Program memory can thus be regarded as two 16-bit word wide address spaces, residing side by side, each with the same address range. TBLRDL and TBLWTL access the space which contains the Least Significant Data Word, and TBLRDH and TBLWTH access the space which contains the Most Significant Data Byte.

Figure 3-3 shows how the EA is created for table operations and data space accesses (PSV = 1). Here, P<23:0> refers to a program space word, whereas D<15:0> refers to a data space word.

A set of table instructions are provided to move byte or word sized data to and from program space.

1. TBLRDL: Table Read Low
   Word: Read the lsw of the program address; P<15:0> maps to D<15:0>.
   Byte: Read one of the LSBs of the program address;
   P<7:0> maps to the destination byte when byte select = 0;
   P<15:8> maps to the destination byte when byte select = 1.
2. TBLWTL: Table Write Low (refer to **Section 6.0 "Flash Program Memory"** for details on Flash Programming)
3. TBLRDH: Table Read High
   Word: Read the most significant word of the program address; P<23:16> maps to D<7:0>; D<15:8> will always be = 0.
   Byte: Read one of the MSBs of the program address;
   P<23:16> maps to the destination byte when byte select = 0;
   The destination byte will always be = 0 when byte select = 1.
4. TBLWTH: Table Write High (refer to **Section 6.0 "Flash Program Memory"** for details on Flash Programming).

FIGURE 3-4: PROGRAM DATA TABLE ACCESS (LEAST SIGNIFICANT WORD)

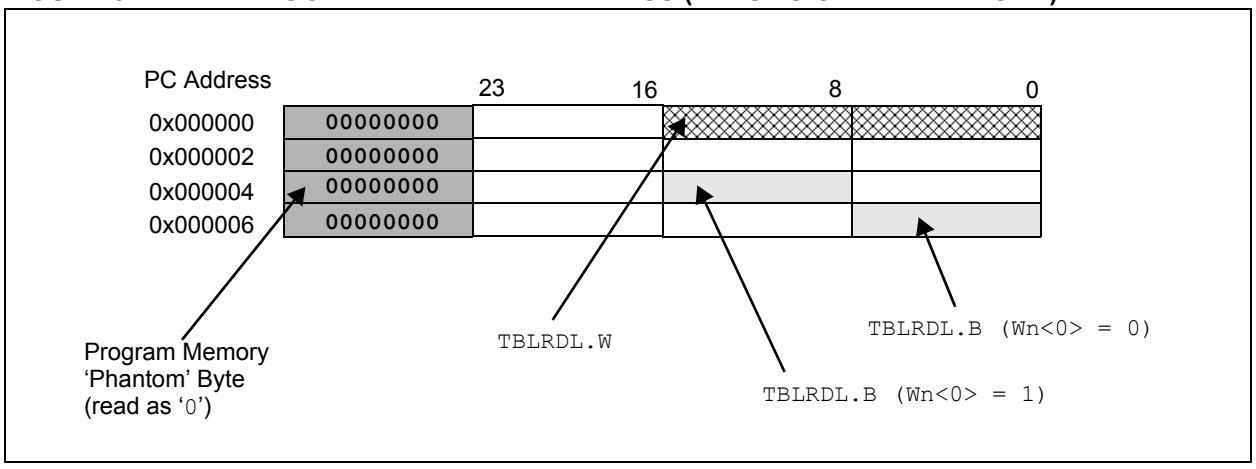
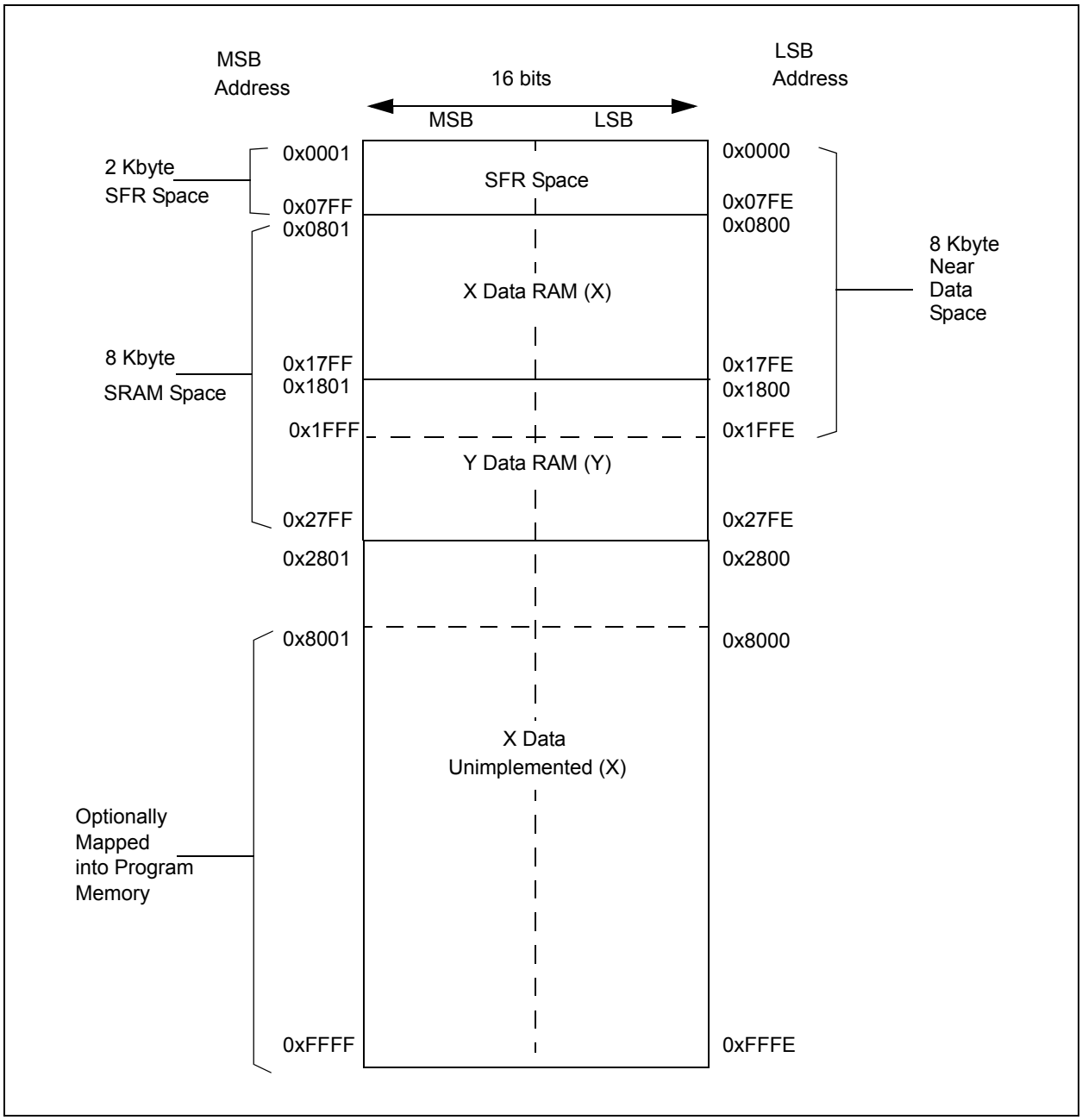


FIGURE 3-8: DATA SPACE MEMORY MAP FOR dsPIC30F6012A/6014A



4.0 ADDRESS GENERATOR UNITS

Note: This data sheet summarizes features of this group of dsPIC30F devices and is not intended to be a complete reference source. For more information on the CPU, peripherals, register descriptions and general device functionality, refer to the "*dsPIC30F Family Reference Manual*" (DS70046). For more information on the device instruction set and programming, refer to the *"16-bit MCU and DSC Programmer's Reference Manual"* (DS70157).

The dsPIC DSC core contains two independent address generator units: the X AGU and Y AGU. The Y AGU supports word sized data reads for the DSP MAC class of instructions only. The dsPIC30F AGUs support:

- Linear Addressing
- Modulo (Circular) Addressing
- Bit-Reversed Addressing

Linear and Modulo Data Addressing modes can be applied to data space or program space. Bit-Reversed Addressing is only applicable to data space addresses.

4.1 Instruction Addressing Modes

The Addressing modes in Table 4-1 form the basis of the Addressing modes optimized to support the specific features of individual instructions. The Addressing modes provided in the MAC class of instructions are somewhat different from those in the other instruction types.

4.1.1 FILE REGISTER INSTRUCTIONS

Most File register instructions use a 13-bit address field (f) to directly address data present in the first 8192 bytes of data memory (Near data space). Most File register instructions employ a working register, W0, which is denoted as WREG in these instructions. The destination is typically either the same File register or WREG (with the exception of the MUL instruction), which writes the result to a register or register pair. The MOV instruction allows additional flexibility and can access the entire data space.

4.1.2 MCU INSTRUCTIONS

The three-operand MCU instructions are of the form:

```
Operand 3 = Operand 1 <function> Operand 2
```

where:

Operand 1 is always a working register (i.e., the Addressing mode can only be Register Direct) which is referred to as Wb.

Operand 2 can be a W register, fetched from data memory or a 5-bit literal. The result location can be either a W register or a data memory location. The following addressing modes are supported by MCU instructions:

- Register Direct
- Register Indirect
- Register Indirect Post-modified
- Register Indirect Pre-modified
- 5-bit or 10-bit Literal

Note: Not all instructions support all the addressing modes given above. Individual instructions may support different subsets of these addressing modes.

TABLE 4-1: FUNDAMENTAL ADDRESSING MODES SUPPORTED

Addressing Mode	Description
File Register Direct	The address of the File register is specified explicitly.
Register Direct	The contents of a register are accessed directly.
Register Indirect	The contents of Wn forms the EA.
Register Indirect Post-modified	The contents of Wn forms the EA. Wn is post-modified (incremented or decremented) by a constant value.
Register Indirect Pre-modified	Wn is pre-modified (incremented or decremented) by a signed constant value to form the EA.
Register Indirect with Register Offset	The sum of Wn and Wb forms the EA.
Register Indirect with Literal Offset	The sum of Wn and a literal forms the EA.

NOTES:

5.2 Reset Sequence

A Reset is not a true exception, because the interrupt controller is not involved in the Reset process. The processor initializes its registers in response to a Reset which forces the PC to zero. The processor then begins program execution at location 0x000000. A GOTO instruction is stored in the first program memory location immediately followed by the address target for the GOTO instruction. The processor executes the GOTO to the specified address and then begins operation at the specified target (start) address.

5.2.1 RESET SOURCES

In addition to external Reset and Power-on Reset (POR), there are 6 sources of error conditions which 'trap' to the Reset vector.

- Watchdog Time-out:
  The watchdog has timed out, indicating that the processor is no longer executing the correct flow of code.
- Uninitialized W Register Trap:
  An attempt to use an uninitialized W register as an address pointer will cause a Reset.
- Illegal Instruction Trap:
  Attempted execution of any unused opcodes will result in an illegal instruction trap. Note that a fetch of an illegal instruction does not result in an illegal instruction trap if that instruction is flushed prior to execution due to a flow change.
- Brown-out Reset (BOR):
  A momentary dip in the power supply to the device has been detected which may result in malfunction.
- Trap Lockout:
  Occurrence of multiple trap conditions simultaneously will cause a Reset.
- Software Reset Instruction

5.3 Traps

Traps can be considered as non-maskable interrupts indicating a software or hardware error, which adhere to a predefined priority, as shown in Table 5-1. They are intended to provide the user a means to correct erroneous operation during debug and when operating within the application.

Note:	If the user does not intend to take corrective action in the event of a trap error condition, these vectors must be loaded with the address of a default handler that simply contains the RESET instruction. If, on the other hand, one of the vectors containing an invalid address is called, an address error trap is generated.

Note that many of these trap conditions can only be detected when they occur. Consequently, the questionable instruction is allowed to complete prior to trap exception processing. If the user chooses to recover from the error, the result of the erroneous action that caused the trap may have to be corrected.

There are 8 fixed priority levels for traps: level 8 through level 15, which implies that the IPL3 is always set during processing of a trap.

If the user is not currently executing a trap, and he sets the IPL<3:0> bits to a value of '0111' (level 7), then all interrupts are disabled but traps can still be processed.

5.3.1 TRAP SOURCES

The following traps are provided with increasing priority. However, since all traps can be nested, priority has little effect.

Math Error Trap:

The math error trap executes under the following four circumstances:

- Should an attempt be made to divide by zero, the divide operation will be aborted on a cycle boundary and the trap taken.
- If enabled, a math error trap will be taken when an arithmetic operation on either accumulator A or B causes an overflow from bit 31 and the accumulator guard bits are not utilized.
- If enabled, a math error trap will be taken when an arithmetic operation on either accumulator A or B causes a catastrophic overflow from bit 39 and all saturation is disabled.
- If the shift amount specified in a shift instruction is greater than the maximum allowed shift amount, a trap will occur.

Address Error Trap:

This trap is initiated when any of the following circumstances occurs:

- A misaligned data word access is attempted
- A data fetch from and unimplemented data memory location is attempted
- A data fetch from an unimplemented program memory location is attempted
- An instruction fetch from vector space is attempted

Note:	In the MAC class of instructions, wherein the data space is split into X and Y data space, unimplemented X space includes all of Y space, and unimplemented Y space includes all of X space.

7.3.2 WRITING A BLOCK OF DATA EEPROM

To write a block of data EEPROM, write to all sixteen latches first, then set the NVMCON register and program the block.

EXAMPLE 7-5: DATA EEPROM BLOCK WRITE

```
    MOV         #LOW_ADDR_WORD,W0  ; Init pointer
    MOV         #HIGH_ADDR_WORD,W1
    MOV         W1,TBLPAG
    MOV         #data1,W2          ; Get 1st data
    TBLWTL      W2,[ W0]++         ; write data
    MOV         #data2,W2          ; Get 2nd data
    TBLWTL      W2,[ W0]++         ; write data
    MOV         #data3,W2          ; Get 3rd data
    TBLWTL      W2,[ W0]++         ; write data
    MOV         #data4,W2          ; Get 4th data
    TBLWTL      W2,[ W0]++         ; write data
    MOV         #data5,W2          ; Get 5th data
    TBLWTL      W2,[ W0]++         ; write data
    MOV         #data6,W2          ; Get 6th data
    TBLWTL      W2,[ W0]++         ; write data
    MOV         #data7,W2          ; Get 7th data
    TBLWTL      W2,[ W0]++         ; write data
    MOV         #data8,W2          ; Get 8th data
    TBLWTL      W2,[ W0]++         ; write data
    MOV         #data9,W2          ; Get 9th data
    TBLWTL      W2,[ W0]++         ; write data
    MOV         #data10,W2         ; Get 10th data
    TBLWTL      W2,[ W0]++         ; write data
    MOV         #data11,W2         ; Get 11th data
    TBLWTL      W2,[ W0]++         ; write data
    MOV         #data12,W2         ; Get 12th data
    TBLWTL      W2,[ W0]++         ; write data
    MOV         #data13,W2         ; Get 13th data
    TBLWTL      W2,[ W0]++         ; write data
    MOV         #data14,W2         ; Get 14th data
    TBLWTL      W2,[ W0]++         ; write data
    MOV         #data15,W2         ; Get 15th data
    TBLWTL      W2,[ W0]++         ; write data
    MOV         #data16,W2         ; Get 16th data
    TBLWTL      W2,[ W0]++         ; write data. The NVMADR captures last table access address.
    MOV         #0x400A,W0         ; Select data EEPROM for multi word op
    MOV         W0,NVMCON          ; Operate Key to allow program operation
    DISI        #5                 ; Block all interrupts with priority <7 for
                                   ; next 5 instructions
    MOV         #0x55,W0
    MOV         W0,NVMKEY          ; Write the 0x55 key
    MOV         #0xAA,W1
    MOV         W1,NVMKEY          ; Write the 0xAA key
    BSET        NVMCON,#WR         ; Start write cycle
    NOP
    NOP
```

7.4 Write Verify

Depending on the application, good programming practice may dictate that the value written to the memory should be verified against the original value. This should be used in applications where excessive writes can stress bits near the specification limit.

7.5 Protection Against Spurious Write

There are conditions when the device may not want to write to the data EEPROM memory. To protect against spurious EEPROM writes, various mechanisms have been built-in. On power-up, the WREN bit is cleared; also, the Power-up Timer prevents EEPROM write.

The write initiate sequence and the WREN bit together help prevent an accidental write during brown-out, power glitch, or software malfunction.

8.3 Input Change Notification Module

The input change notification module provides the dsPIC30F devices the ability to generate interrupt requests to the processor, in response to a change of state on selected input pins. This module is capable of detecting input change of states even in Sleep mode, when the clocks are disabled. There are up to 24 external signals (CN0 through CN23) that may be selected (enabled) for generating an interrupt request on a change of state.

TABLE 8-10: INPUT CHANGE NOTIFICATION REGISTER MAP FOR dsPIC30F6011A/6012A (BITS 15-8)(1)

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Reset State
CNEN1	00C0	CN15IE	CN14IE	CN13IE	CN12IE	CN11IE	CN10IE	CN9IE	CN8IE	0000 0000 0000 0000
CNEN2	00C2	—	—	—	—	—	—	—	—	0000 0000 0000 0000
CNPU1	00C4	CN15PUE	CN14PUE	CN13PUE	CN12PUE	CN11PUE	CN10PUE	CN9PUE	CN8PUE	0000 0000 0000 0000
CNPU2	00C6	—	—	—	—	—	—	—	—	0000 0000 0000 0000

Legend: u = uninitialized bit; — = unimplemented bit, read as '0'
Note 1: Refer to the *"dsPIC30F Family Reference Manual"* (DS70046) for descriptions of register bit fields.

TABLE 8-11: INPUT CHANGE NOTIFICATION REGISTER MAP FOR dsPIC30F6011A/6012A (BITS 7-0)(1)

SFR Name	Addr.	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
CNEN1	00C0	CN7IE	CN6IE	CN5IE	CN4IE	CN3IE	CN2IE	CN1IE	CN0IE	0000 0000 0000 0000
CNEN2	00C2	—	—	—	—	—	CN18IE	CN17IE	CN16IE	0000 0000 0000 0000
CNPU1	00C4	CN7PUE	CN6PUE	CN5PUE	CN4PUE	CN3PUE	CN2PUE	CN1PUE	CN0PUE	0000 0000 0000 0000
CNPU2	00C6	—	—	—	—	—	CN18PUE	CN17PUE	CN16PUE	0000 0000 0000 0000

Legend: u = uninitialized bit; — = unimplemented bit, read as '0'
Note 1: Refer to the *"dsPIC30F Family Reference Manual"* (DS70046) for descriptions of register bit fields.

TABLE 8-12: INPUT CHANGE NOTIFICATION REGISTER MAP FOR dsPIC30F6013A/6014A (BITS 15-8)(1)

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Reset State
CNEN1	00C0	CN15IE	CN14IE	CN13IE	CN12IE	CN11IE	CN10IE	CN9IE	CN8IE	0000 0000 0000 0000
CNEN2	00C2	—	—	—	—	—	—	—	—	0000 0000 0000 0000
CNPU1	00C4	CN15PUE	CN14PUE	CN13PUE	CN12PUE	CN11PUE	CN10PUE	CN9PUE	CN8PUE	0000 0000 0000 0000
CNPU2	00C6	—	—	—	—	—	—	—	—	0000 0000 0000 0000

Legend: u = uninitialized bit; — = unimplemented bit, read as '0'
Note 1: Refer to the *"dsPIC30F Family Reference Manual"* (DS70046) for descriptions of register bit fields.

TABLE 8-13: INPUT CHANGE NOTIFICATION REGISTER MAP FOR dsPIC30F6013A/6014A (BITS 7-0)(1)

SFR Name	Addr.	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
CNEN1	00C0	CN7IE	CN6IE	CN5IE	CN4IE	CN3IE	CN2IE	CN1IE	CN0IE	0000 0000 0000 0000
CNEN2	00C2	CN23IE	CN22IE	CN21IE	CN20IE	CN19IE	CN18IE	CN17IE	CN16IE	0000 0000 0000 0000
CNPU1	00C4	CN7PUE	CN6PUE	CN5PUE	CN4PUE	CN3PUE	CN2PUE	CN1PUE	CN0PUE	0000 0000 0000 0000
CNPU2	00C6	CN23PUE	CN22PUE	CN21PUE	CN20PUE	CN19PUE	CN18PUE	CN17PUE	CN16PUE	0000 0000 0000 0000

Legend: u = uninitialized bit; — = unimplemented bit, read as '0'
Note 1: Refer to the *"dsPIC30F Family Reference Manual"* (DS70046) for descriptions of register bit fields.

FIGURE 10-2: 16-BIT TIMER2 BLOCK DIAGRAM

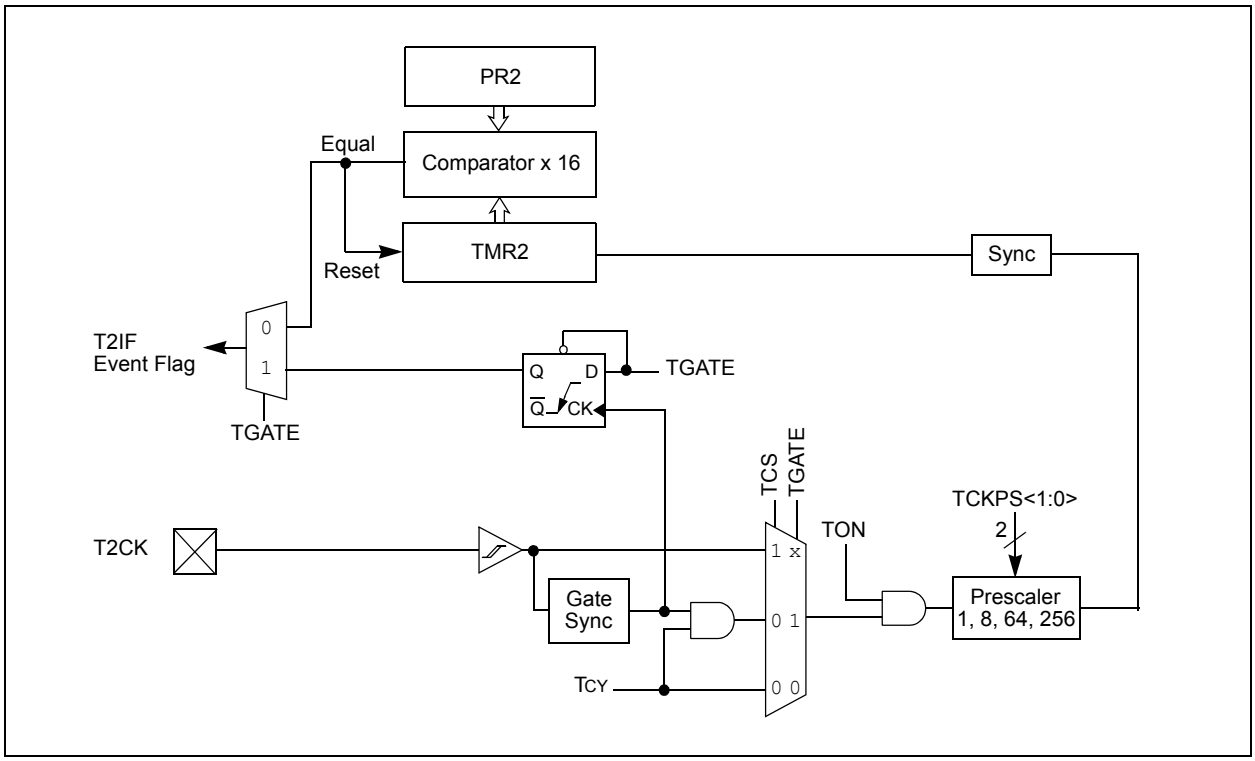
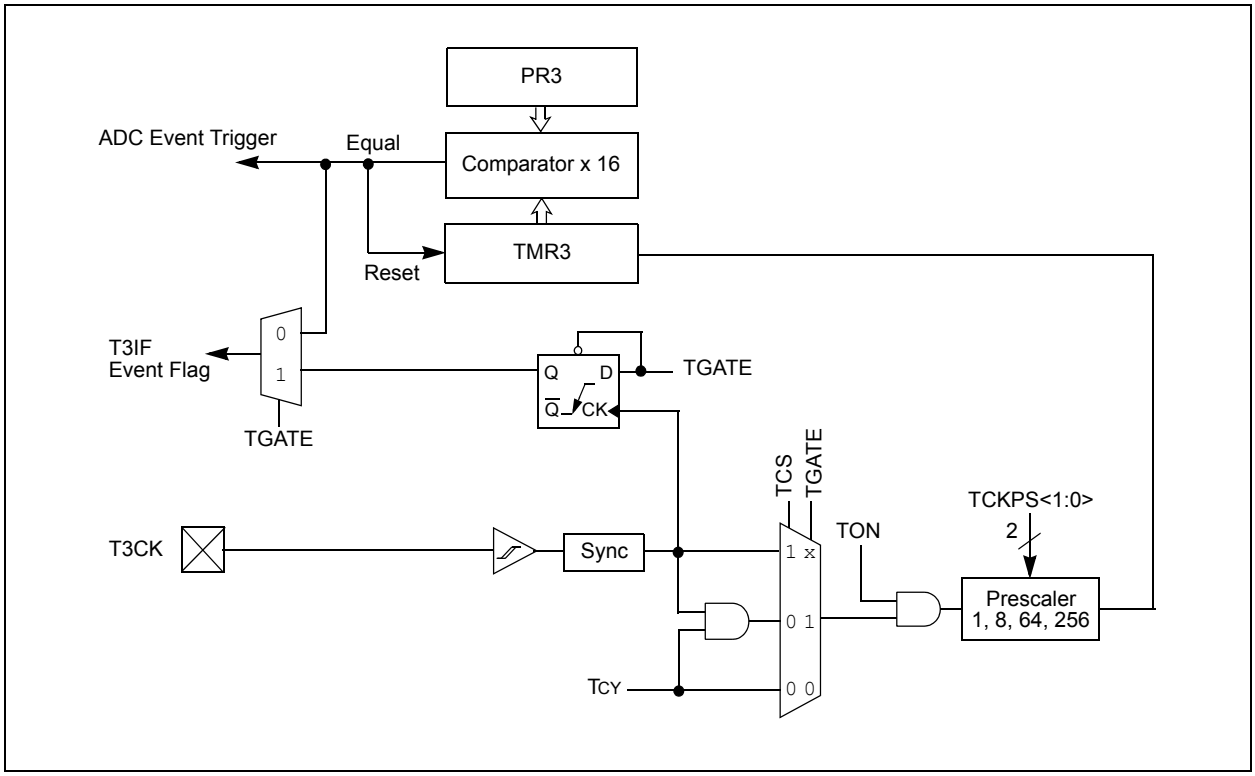


FIGURE 10-3: 16-BIT TIMER3 BLOCK DIAGRAM



14.0 SPI™ MODULE

Note:	This data sheet summarizes features of this group of dsPIC30F devices and is not intended to be a complete reference source. For more information on the CPU, peripherals, register descriptions and general device functionality, refer to the *"dsPIC30F Family Reference Manual"* (DS70046).

The Serial Peripheral Interface (SPI™) module is a synchronous serial interface. It is useful for communicating with other peripheral devices, such as EEPROMs, shift registers, display drivers and A/D converters, or other microcontrollers. It is compatible with Motorola's SPI and SIOP interfaces.

14.1 Operating Function Description

Each SPI module consists of a 16-bit shift register, SPIxSR (where x = 1 or 2), used for shifting data in and out, and a buffer register, SPIxBUF. A control register, SPIxCON, configures the module. Additionally, a status register, SPIxSTAT, indicates various status conditions.

The serial interface consists of 4 pins: SDIx (serial data input), SDOx (serial data output), SCKx (shift clock input or output), and $\overline{SSx}$ (active-low slave select).

In Master mode operation, SCK is a clock output but in Slave mode, it is a clock input.

A series of eight (8) or sixteen (16) clock pulses shift out bits from the SPIxSR to SDOx pin and simultaneously shift in data from SDIx pin. An interrupt is generated when the transfer is complete and the corresponding interrupt flag bit (SPI1IF or SPI2IF) is set. This interrupt can be disabled through an interrupt enable bit (SPI1IE or SPI2IE).

The receive operation is double-buffered. When a complete byte is received, it is transferred from SPIxSR to SPIxBUF.

If the receive buffer is full when new data is being transferred from SPIxSR to SPIxBUF, the module will set the SPIROV bit indicating an overflow condition. The transfer of the data from SPIxSR to SPIxBUF will not be completed and the new data will be lost. The module will not respond to SCL transitions while SPIROV is '1', effectively disabling the module until SPIxBUF is read by user software.

Transmit writes are also double-buffered. The user writes to SPIxBUF. When the master or slave transfer is completed, the contents of the shift register (SPIxSR) are moved to the receive buffer. If any transmit data has been written to the buffer register, the contents of the transmit buffer are moved to SPIxSR. The received data is thus placed in SPIxBUF and the transmit data in SPIxSR is ready for the next transfer.

Note:	Both the transmit buffer (SPIxTXB) and the receive buffer (SPIxRXB) are mapped to the same register address, SPIxBUF.

In Master mode, the clock is generated by prescaling the system clock. Data is transmitted as soon as a value is written to SPIxBUF. The interrupt is generated at the middle of the transfer of the last bit.

In Slave mode, data is transmitted and received as external clock pulses appear on SCK. Again, the interrupt is generated when the last bit is latched. If $\overline{SSx}$ control is enabled, then transmission and reception are enabled only when $\overline{SSx}$ = low. The SDOx output will be disabled in $\overline{SSx}$ mode with $\overline{SSx}$ high.

The clock provided to the module is (FOSC/4). This clock is then prescaled by the primary (PPRE<1:0>) and the secondary (SPRE<2:0>) prescale factors. The CKE bit determines whether transmit occurs on transition from active clock state to Idle clock state, or vice versa. The CKP bit selects the Idle state (high or low) for the clock.

14.1.1 WORD AND BYTE COMMUNICATION

A control bit, MODE16 (SPIxCON<10>), allows the module to communicate in either 16-bit or 8-bit mode. 16-bit operation is identical to 8-bit operation except that the number of bits transmitted is 16 instead of 8.

The user software must disable the module prior to changing the MODE16 bit. The SPI module is reset when the MODE16 bit is changed by the user.

A basic difference between 8-bit and 16-bit operation is that the data is transmitted out of bit 7 of the SPIxSR for 8-bit operation, and data is transmitted out of bit15 of the SPIxSR for 16-bit operation. In both modes, data is shifted into bit 0 of the SPIxSR.

14.1.2 SDOx DISABLE

A control bit, DISSDO, is provided to the SPIxCON register to allow the SDOx output to be disabled. This will allow the SPI module to be connected in an input only configuration. SDO can also be used for general purpose I/O.

TABLE 17-2: CAN2 REGISTER MAP(1)

SFR Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset State
C2RXF0SID	03C0	—	—	—	Receive Acceptance Filter 0 Standard Identifier <10:0>											—	EXIDE	000u uuuu uuuu uu0u
C2RXF0EIDH	03C2	—	—	—	—	Receive Acceptance Filter 0 Extended Identifier <17:6>												0000 uuuu uuuu uuuu
C2RXF0EIDL	03C4	Receive Acceptance Filter 0 Extended Identifier <5:0>						—	—	—	—	—	—	—	—	—	—	uuuu uu00 0000 0000
C2RXF1SID	03C8	—	—	—	Receive Acceptance Filter 1 Standard Identifier <10:0>											—	EXIDE	000u uuuu uuuu uu0u
C2RXF1EIDH	03CA	—	—	—	—	Receive Acceptance Filter 1 Extended Identifier <17:6>												0000 uuuu uuuu uuuu
C2RXF1EIDL	03CC	Receive Acceptance Filter 1 Extended Identifier <5:0>						—	—	—	—	—	—	—	—	—	—	uuuu uu00 0000 0000
C2RXF2SID	03D0	—	—	—	Receive Acceptance Filter 2 Standard Identifier <10:0>											—	EXIDE	000u uuuu uuuu uu0u
C2RXF2EIDH	03D2	—	—	—	—	Receive Acceptance Filter 2 Extended Identifier <17:6>												0000 uuuu uuuu uuuu
C2RXF2EIDL	03D4	Receive Acceptance Filter 2 Extended Identifier <5:0>						—	—	—	—	—	—	—	—	—	—	uuuu uu00 0000 0000
C2RXF3SID	03D8	—	—	—	Receive Acceptance Filter 3 Standard Identifier <10:0>											—	EXIDE	000u uuuu uuuu uu0u
C2RXF3EIDH	03DA	—	—	—	—	Receive Acceptance Filter 3 Extended Identifier <17:6>												0000 uuuu uuuu uuuu
C2RXF3EIDL	03DC	Receive Acceptance Filter 3 Extended Identifier <5:0>						—	—	—	—	—	—	—	—	—	—	uuuu uu00 0000 0000
C2RXF4SID	03E0	—	—	—	Receive Acceptance Filter 4 Standard Identifier <10:0>											—	EXIDE	000u uuuu uuuu uu0u
C2RXF4EIDH	03E2	—	—	—	—	Receive Acceptance Filter 4 Extended Identifier <17:6>												0000 uuuu uuuu uuuu
C2RXF4EIDL	03E4	Receive Acceptance Filter 4 Extended Identifier <5:0>						—	—	—	—	—	—	—	—	—	—	uuuu uu00 0000 0000
C2RXF5SID	03E8	—	—	—	Receive Acceptance Filter 5 Standard Identifier <10:0>											—	EXIDE	000u uuuu uuuu uu0u
C2RXF5EIDH	03EA	—	—	—	—	Receive Acceptance Filter 5 Extended Identifier <17:6>												0000 uuuu uuuu uuuu
C2RXF5EIDL	03EC	Receive Acceptance Filter 5 Extended Identifier <5:0>						—	—	—	—	—	—	—	—	—	—	uuuu uu00 0000 0000
C2RXM0SID	03F0	—	—	—	Receive Acceptance Mask 0 Standard Identifier <10:0>											—	MIDE	000u uuuu uuuu uu0u
C2RXM0EIDH	03F2	—	—	—	—	Receive Acceptance Mask 0 Extended Identifier <17:6>												0000 uuuu uuuu uuuu
C2RXM0EIDL	03F4	Receive Acceptance Mask 0 Extended Identifier <5:0>						—	—	—	—	—	—	—	—	—	—	uuuu uu00 0000 0000
C2RXM1SID	03F8	—	—	—	Receive Acceptance Mask 1 Standard Identifier <10:0>											—	MIDE	000u uuuu uuuu uu0u
C2RXM1EIDH	03FA	—	—	—	—	Receive Acceptance Mask 1 Extended Identifier <17:6>												0000 uuuu uuuu uuuu
C2RXM1EIDL	03FC	Receive Acceptance Mask 1 Extended Identifier <5:0>						—	—	—	—	—	—	—	—	—	—	uuuu uu00 0000 0000
C2TX2SID	0400	Transmit Buffer 2 Standard Identifier <10:6>					—	—	—	Transmit Buffer 2 Standard Identifier <5:0>						SRR	TXIDE	uuuu u000 uuuu uuuu
C2TX2EID	0402	Transmit Buffer 2 Extended Identifier <17:14>				—	—	—	—	Transmit Buffer 2 Extended Identifier <13:6>								uuuu 0000 uuuu uuuu
C2TX2DLC	0404	Transmit Buffer 2 Extended Identifier <5:0>						TXRTR	TXRB1	TXRB0	DLC<3:0>				—	—	—	uuuu uuuu uuuu u000
C2TX2B1	0406	Transmit Buffer 2 Byte 1								Transmit Buffer 2 Byte 0								uuuu uuuu uuuu uuuu
C2TX2B2	0408	Transmit Buffer 2 Byte 3								Transmit Buffer 2 Byte 2								uuuu uuuu uuuu uuuu
C2TX2B3	040A	Transmit Buffer 2 Byte 5								Transmit Buffer 2 Byte 4								uuuu uuuu uuuu uuuu
C2TX2B4	040C	Transmit Buffer 2 Byte 7								Transmit Buffer 2 Byte 6								uuuu uuuu uuuu uuuu
C2TX2CON	040E	—	—	—	—	—	—	—	—	—	TXABT	TXLARB	TXERR	TXREQ	—	TXPRI<1:0>		0000 0000 0000 0000
C2TX1SID	0410	Transmit Buffer 1 Standard Identifier <10:6>					—	—	—	Transmit Buffer 1 Standard Identifier <5:0>						SRR	TXIDE	uuuu u000 uuuu uuuu
C2TX1EID	0412	Transmit Buffer 1 Extended Identifier <17:14>				—	—	—	—	Transmit Buffer 1 Extended Identifier <13:6>								uuuu 0000 uuuu uuuu
C2TX1DLC	0414	Transmit Buffer 1 Extended Identifier <5:0>						TXRTR	TXRB1	TXRB0	DLC<3:0>				—	—	—	uuuu uuuu uuuu u000

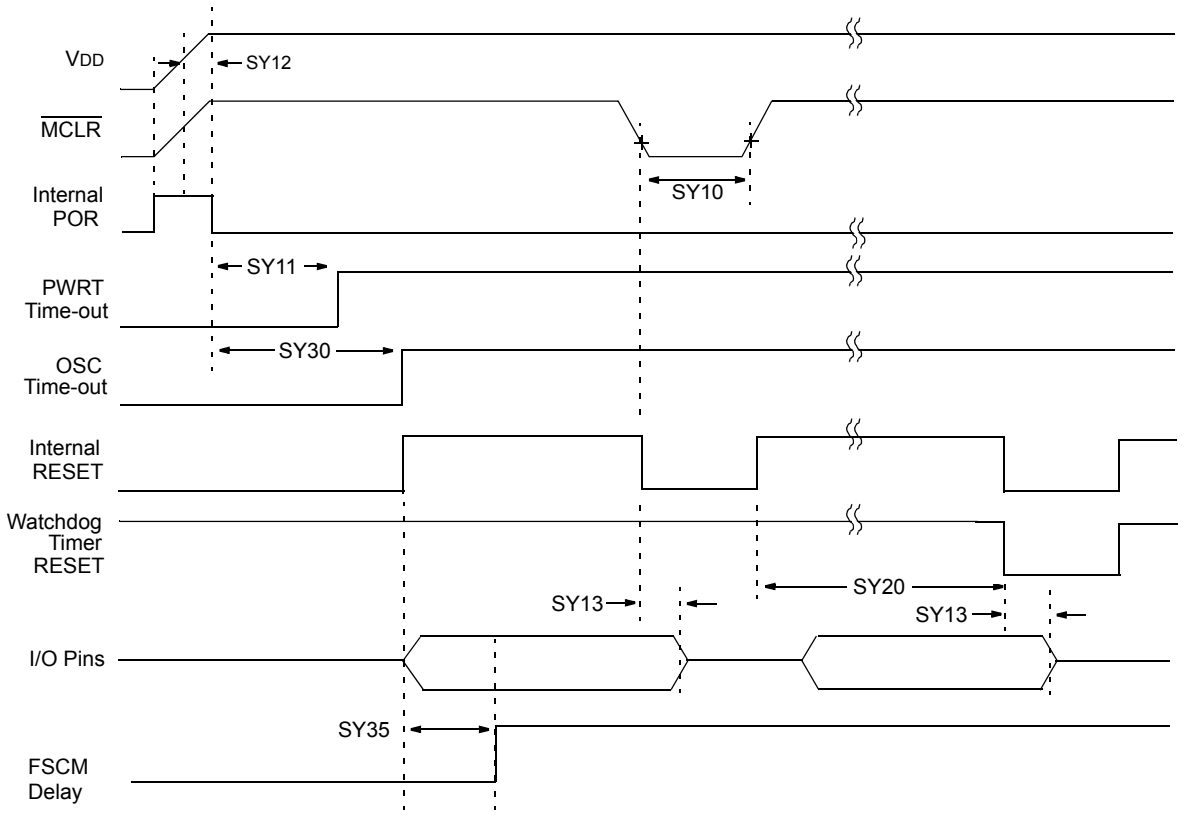
Legend: u = uninitialized bit; — = unimplemented bit, read as '0'

Note 1: Refer to the *"dsPIC30F Family Reference Manual"* (DS70046) for descriptions of register bit fields.

TABLE 21-2: INSTRUCTION SET OVERVIEW (CONTINUED)

Base Instr #	Assembly Mnemonic	Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
9	BTG	BTG f,#bit4	Bit Toggle f	1	1	None
		BTG Ws,#bit4	Bit Toggle Ws	1	1	None
10	BTSC	BTSC f,#bit4	Bit Test f, Skip if Clear	1	1 (2 or 3)	None
		BTSC Ws,#bit4	Bit Test Ws, Skip if Clear	1	1 (2 or 3)	None
11	BTSS	BTSS f,#bit4	Bit Test f, Skip if Set	1	1 (2 or 3)	None
		BTSS Ws,#bit4	Bit Test Ws, Skip if Set	1	1 (2 or 3)	None
12	BTST	BTST f,#bit4	Bit Test f	1	1	Z
		BTST.C Ws,#bit4	Bit Test Ws to C	1	1	C
		BTST.Z Ws,#bit4	Bit Test Ws to Z	1	1	Z
		BTST.C Ws,Wb	Bit Test Ws<Wb> to C	1	1	C
		BTST.Z Ws,Wb	Bit Test Ws<Wb> to Z	1	1	Z
13	BTSTS	BTSTS f,#bit4	Bit Test then Set f	1	1	Z
		BTSTS.C Ws,#bit4	Bit Test Ws to C, then Set	1	1	C
		BTSTS.Z Ws,#bit4	Bit Test Ws to Z, then Set	1	1	Z
14	CALL	CALL lit23	Call subroutine	2	2	None
		CALL Wn	Call indirect subroutine	1	2	None
15	CLR	CLR f	f = 0x0000	1	1	None
		CLR WREG	WREG = 0x0000	1	1	None
		CLR Ws	Ws = 0x0000	1	1	None
		CLR Acc,Wx,Wxd,Wy,Wyd,AWB	Clear Accumulator	1	1	OA,OB,SA,SB
16	CLRWDT	CLRWDT	Clear Watchdog Timer	1	1	WDTO,Sleep
17	COM	COM f	$f = \overline{f}$	1	1	N,Z
		COM f,WREG	$WREG = \overline{f}$	1	1	N,Z
		COM Ws,Wd	$Wd = \overline{Ws}$	1	1	N,Z
18	CP	CP f	Compare f with WREG	1	1	C,DC,N,OV,Z
		CP Wb,#lit5	Compare Wb with lit5	1	1	C,DC,N,OV,Z
		CP Wb,Ws	Compare Wb with Ws (Wb - Ws)	1	1	C,DC,N,OV,Z
19	CP0	CP0 f	Compare f with 0x0000	1	1	C,DC,N,OV,Z
		CP0 Ws	Compare Ws with 0x0000	1	1	C,DC,N,OV,Z
20	CPB	CPB f	Compare f with WREG, with Borrow	1	1	C,DC,N,OV,Z
		CPB Wb,#lit5	Compare Wb with lit5, with Borrow	1	1	C,DC,N,OV,Z
		CPB Wb,Ws	Compare Wb with Ws, with Borrow (Wb - Ws - $\overline{C}$)	1	1	C,DC,N,OV,Z
21	CPSEQ	CPSEQ Wb, Wn	Compare Wb with Wn, skip if =	1	1 (2 or 3)	None
22	CPSGT	CPSGT Wb, Wn	Compare Wb with Wn, skip if >	1	1 (2 or 3)	None
23	CPSLT	CPSLT Wb, Wn	Compare Wb with Wn, skip if <	1	1 (2 or 3)	None
24	CPSNE	CPSNE Wb, Wn	Compare Wb with Wn, skip if ≠	1	1 (2 or 3)	None
25	DAW	DAW Wn	Wn = decimal adjust Wn	1	1	C
26	DEC	DEC f	f = f -1	1	1	C,DC,N,OV,Z
		DEC f,WREG	WREG = f -1	1	1	C,DC,N,OV,Z
		DEC Ws,Wd	Wd = Ws - 1	1	1	C,DC,N,OV,Z
27	DEC2	DEC2 f	f = f -2	1	1	C,DC,N,OV,Z
		DEC2 f,WREG	WREG = f -2	1	1	C,DC,N,OV,Z
		DEC2 Ws,Wd	Wd = Ws - 2	1	1	C,DC,N,OV,Z
28	DISI	DISI #lit14	Disable Interrupts for k instruction cycles	1	1	None

FIGURE 23-6: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING CHARACTERISTICS



Note: Refer to Figure 23-3 for load conditions.

TABLE 23-39: 12-BIT ADC TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.7V to 5.5V (unless otherwise stated) Operating temperature -40°C ≤TA ≤+85°C for Industrial -40°C ≤TA ≤+125°C for Extended				
Param No.	**Symbol**	**Characteristic**	**Min.**	**Typ**	**Max.**	**Units**	**Conditions**
Clock Parameters							
AD50	TAD	ADC Clock Period	—	334	—	ns	VDD = 3-5.5V **(Note 1)**
AD51	tRC	ADC Internal RC Oscillator Period	1.2	1.5	1.8	µs	
Conversion Rate							
AD55	tCONV	Conversion Time	—	14 TAD		ns	
AD56	FCNV	Throughput Rate	—	200	—	ksps	VDD = VREF = 3-5.5V
AD57	TSAMP	Sample Time	—	1 TAD	—	ns	VDD = 3-5.5V Source resistance Rs = 0-2.5 kΩ
Timing Parameters							
AD60	tPCS	Conversion Start from Sample Trigger	—	1 TAD	—	ns	
AD61	tPSS	Sample Start from Setting Sample (SAMP) Bit	0.5 TAD	—	1.5 TAD	ns	
AD62	tCSS	Conversion Completion to Sample Start (ASAM = 1)	—	0.5 TAD	—	ns	
AD63	tDPU(2)	Time to Stabilize Analog Stage from ADC Off to ADC On	—	—	20	µs	

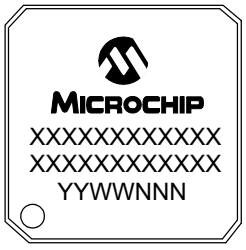
Note 1: Because the sample caps will eventually lose charge, clock rates below 10 kHz can affect linearity performance, especially at elevated temperatures.

2: tDPU is the time required for the ADC module to stabilize when it is turned on (ADCON1<ADON> = 1). During this time the ADC result is indeterminate.

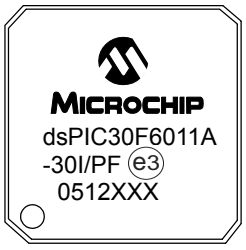
24.0 PACKAGING INFORMATION

24.1 Package Marking Information

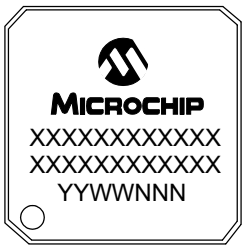
64-Lead TQFP



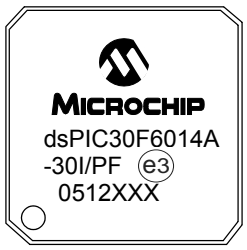
Example



80-Lead TQFP



Example

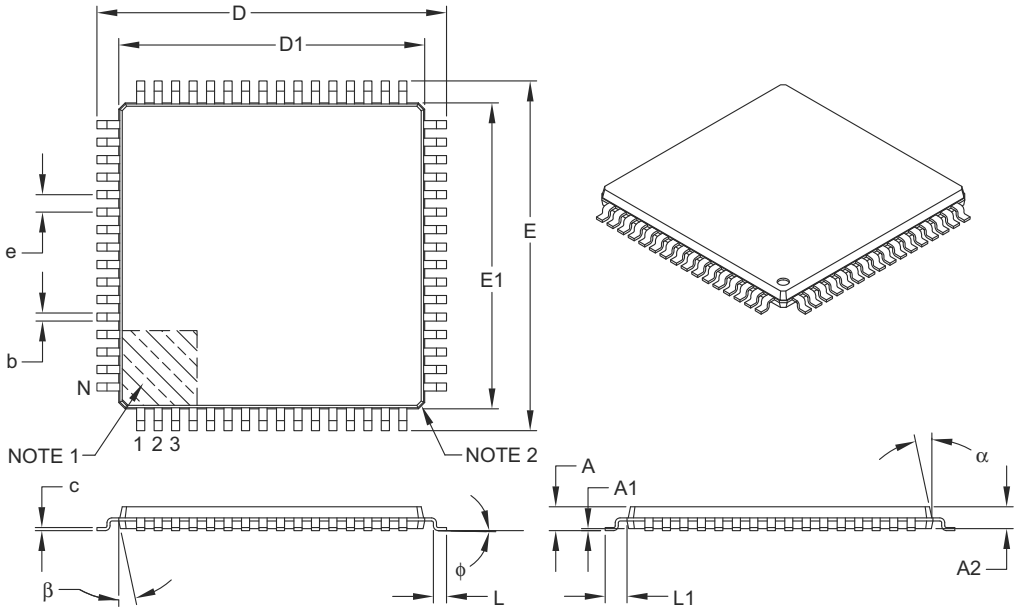


Legend:	XX...X	Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week ‘01’)
	NNN	Alphanumeric traceability code
	(e3)	Pb-free JEDEC designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

64-Lead Plastic Thin Quad Flatpack (PF) – 14x14x1 mm Body, 2.00 mm [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Leads	N		64	
Lead Pitch	e		0.80 BSC	
Overall Height	A	–	–	1.20
Molded Package Thickness	A2	0.95	1.00	1.05
Standoff	A1	0.05	–	0.15
Foot Length	L	0.45	0.60	0.75
Footprint	L1		1.00 REF	
Foot Angle	ϕ	0°	3.5°	7°
Overall Width	E		16.00 BSC	
Overall Length	D		16.00 BSC	
Molded Package Width	E1		14.00 BSC	
Molded Package Length	D1		14.00 BSC	
Lead Thickness	c	0.09	–	0.20
Lead Width	b	0.30	0.37	0.45
Mold Draft Angle Top	α	11°	12°	13°
Mold Draft Angle Bottom	β	11°	12°	13°

Notes:

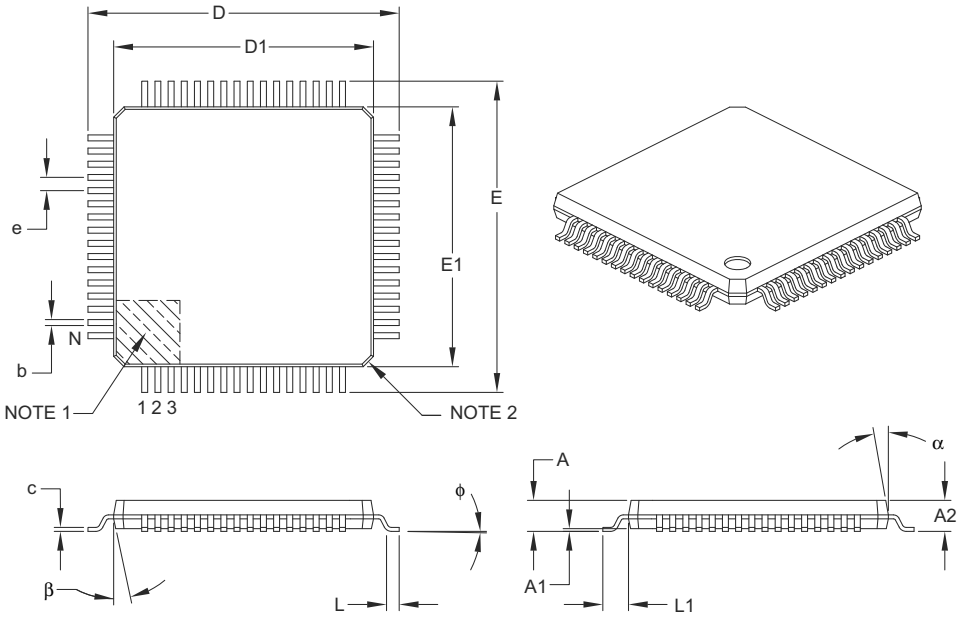
1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Chamfers at corners are optional; size may vary.
3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-066B

64-Lead Plastic Thin Quad Flatpack (PT) – 10x10x1 mm Body, 2.00 mm [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Leads	N		64	
Lead Pitch	e		0.50 BSC	
Overall Height	A	–	–	1.20
Molded Package Thickness	A2	0.95	1.00	1.05
Standoff	A1	0.05	–	0.15
Foot Length	L	0.45	0.60	0.75
Footprint	L1		1.00 REF	
Foot Angle	φ	0°	3.5°	7°
Overall Width	E		12.00 BSC	
Overall Length	D		12.00 BSC	
Molded Package Width	E1		10.00 BSC	
Molded Package Length	D1		10.00 BSC	
Lead Thickness	c	0.09	–	0.20
Lead Width	b	0.17	0.22	0.27
Mold Draft Angle Top	α	11°	12°	13°
Mold Draft Angle Bottom	β	11°	12°	13°

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Chamfers at corners are optional; size may vary.
3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

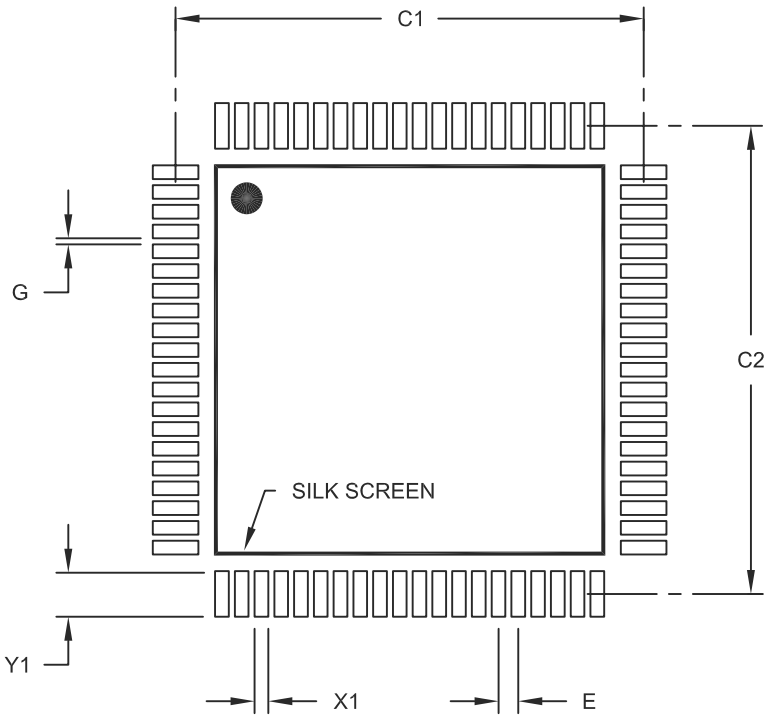
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-085B

80-Lead Plastic Thin Quad Flatpack (PF) – 14x14x1 mm Body, 2.00 mm Footprint [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.65 BSC	
Contact Pad Spacing	C1		15.40	
Contact Pad Spacing	C2		15.40	
Contact Pad Width (X80)	X1			0.45
Contact Pad Length (X80)	Y1			1.50
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2116B

Revision E (February 2011)

This revision includes minor typographical and formatting changes throughout the data sheet text.

The major changes are referenced by their respective section in Table A-1.

TABLE A-1: MAJOR SECTION UPDATES

Section Name	Update Description
Section 20.0 "System Integration"	Added a shaded note on OSCTUN functionality in **Section 20.2.5 "Fast RC Oscillator (FRC)"**.
Section 23.0 "Electrical Characteristics"	Updated the maximum MIPS for the Operating MIPS vs. Voltage VDD range of 3.0-3.6V for dsPIC30F601XA-20I and dsPIC30F601XA-30I devices (see Table 23-1). Added Operating Current (IDD) parameters DC27a and DC27b (see Table 23-5). Added Idle Current (IIDLE) parameters DC47a and DC47b (see Table 23-6). Updated the maximum value for parameter DI19 and the minimum value for parameter DI29 in the I/O Pin Input Specifications (see Table 23-8). Removed parameter D136 and updated the minimum, typical, maximum, and conditions for parameters D122 and D134 in the Program and EEPROM specifications (see Table 23-12).

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